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			VALLIERE Jérôme	03/10/2024
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1.0 Objective

This specification defines the performance, test, quality and reliability requirements of the MicroSpace™ product.

2.0 Scope

This specification is applicable to the termination characteristics of the MicroSpace[™] family of products which provides a unique design enables LV214 Severity-2 and performs at 1.8, 1.5 and 1.27mm pitch. MicroSpace[™] will be available in single (Side-To-Side or Staggered) and double row versions, with top and side latch configuration.

3.0 Ratings

- 3.1 Operating Voltage Rating = 12V-48V (For customer specification and more details, please contact us)
- 3.2 Operating Current Rating =
 - 1.27mm pitch: 4A max, T° rise : 30°C max
 - 1.5mm pitch: 3A max, T° rise : 30°C max
 - 1.8mm pitch: 2A max, T° rise: 30°C max
- 3.3 Operating Temperature Range = -40°C to +130°C (to 105°C for HDT plated CTW)

4.0 Applicable Documents

- 4.1 AFCI Specifications
 - 4.1.1 Engineering drawings
 - 4.1.2 Process drawings
 - 4.1.3 Application specification(s)
 - GS-20-0513 : MicroSpace™ CTW application specification
 - 4.1.4 Material specification(s)
- 4.2 Industry or Trade Association standards
 - 4.2.1 VW 75174: Motor Vehicle Connectors Test Specification
 - 4.2.2 VW 60330: Crimp Connections Solderless Electrical Connections
- 4.3 National or International Standards
 - 4.3.1 Flammability: UL94V-0 or similar applicable specification
 - 4.3.2 EIA 364: Electrical Connector/Socket Test Procedures Including Environmental Classifications.
- 4.4 AFCI Laboratory Reports Supporting Data
- 4.5 Safety Agency Approvals

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5.0 Requirements

5.1 Qualification

Connectors furnished under this specification shall be capable of meeting the qualification test requirements specified herein.

5.2 Material

The material for each component shall be as specified herein or equivalent.

- Contacts High Conductivity Copper alloy
- Housing High Temperature Thermoplastic Glass Filled, UL 94V-0

5.3 Finish

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The finish for applicable components shall be as specified herein or equivalent.

- Full Tin Plated over Nickel underlayer
- Selective Gold Plated over Nickel underlayer
- Hot-dip Tinned plated over copper alloy (CTW)

5.4 Design and Construction

Connectors shall be of the design, construction, and physical dimensions specified on the applicable product drawing. There shall be no cracks, burrs, or other physical defects that may impair performance.

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6.0 Electrical, Mechanical and Environmental Tests

ITEM	TESTS	REQUIRMENTS	PROCEDURES
6.1	PG0 Inspection of as-received condition	 Visual inspection Contact resistance < 30mΩ Insulation resistance > 100 MΩ 	VW 75174
6.2	PG1 Dimensions	Visual inspectionMeasurement reports	VW 75174
6.3	PG2 Material and surface analysis, contacts	Visual inspectionMaterial specifications of contacts parts	VW 75174
6.4	PG3 Material and surface analysis, housings and single-wire seals	Visual inspectionMaterial specifications of housings and single-wire seals	VW 75174
6.5	PG4 Contact engagement length	 Visual inspection Contacts engagement length > 1mm Clearance > 0mm (worst case) 	VW 75174
6.6	PG5 Mechanical and thermal relaxation behavior	Visual inspectionContact opening variationNormal contact force variation	VW 75174

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	T	T	T -
6.7	PG6 Interaction between contact and housing	 Visual inspection Drop test Primary lock/latch play Secondary lock/latch play TPA opening (correct assembled terminals) > 50N (Fo) TPA closing (correct assembled terminals) < 50N (Fs) TPA closing (improperly assembled terminals) > 100N or > 3xFs 	VW 75174
6.8	PG7 Handling and functional reliability of the housing	 Visual inspection Keying efficiency > 80N or > 3xFe Polarizing efficiency > 80N or > 3xFi Positive locking retention > 60N Insertion/actuation force < 75N (Fi) 	VW 75174
6.9	PG8 Insertion and retention forces of the contact parts in the housing	 Visual inspection Terminal insertion force < 3N Terminal retention force 1st locking only > 10N (2) 2nd locking only > 35N (1) 	VW 75174
6.10	PG9 Pin insertion inclination/misuse safe	- Examination is performed using CAD	VW 75174
6.11	PG10 Contacts: conductor pull- out strength	 Visual inspection Conductor pull-out strength: AWG 22: > 50N (1) AWG 24: > 35N (2) AWG 26: > 25N (2) AWG 28: > 15N (2) 	VW 75174

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6.12	PG11 Contacts: Insertion and removal forces, mating cycle frequency	 Visual inspection Mating cycles: 20 Contact opening variation Plugging/Removal force variation 	VW 75174
6.13	PG12 Current heating, derating	Visual inspectionDerating curve	VW 75174
6.14	PG13 Housing influence on the derating	Visual inspectionDerating curve	VW 75174
6.15	PG14 Thermal time constant (current excess temperature at n times rated current)	Visual inspectionRating curve	VW 75174
6.16	PG15 Electrical stress test	 Visual inspection Contact opening variation Contact resistance < 30mΩ Derating curve HDT CTW -40°C to 105°C / 4Amp 	VW 75174
6.17	PG16 Friction corrosion	Visual inspectionContact resistance variation	VW 75174
6.18	PG17 Dynamic load	 Visual inspection Tin (Pre plated): Severity: 1 Tin (Post plated) & Gold: Severity: 3 Contact resistance < 30mΩ 	VW 75174
6.19	PG18A Coastal climate load	 Visual inspection Contact resistance < 30mΩ 	VW 75174
6.20	PG19 Environmental simulation	- Visual inspection	VW 75174

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		- Contact resistance < 50mΩ ⁽¹⁾	
6.21	PG20 Climate load of the housing	 Visual inspection Insulation resistance > 100 MΩ 	VW 75174
6.22	PG21 Long-term temperature aging	 Visual inspection Contact resistance < 30mΩ Drop test Conductor pull-out strength : AWG 22 : > 50N (1) AWG 24 : > 35N (2) AWG 26 : > 25N (2) AWG 28 : > 15N (2) 	VW 75174
6.23	PG22A Resistance to chemicals	 Visual inspection Insulation resistance > 100 MΩ No functionally significant structural or dimensional change 	VW 75174-2
6.24	PG24 Impenetrability to paint	- Visual inspection	VW 75174-2
6.25	PG28 Latching noise	- L _{Apeak} ≥ 50 dB(A) ⁽²⁾	VW 75174-2
6.26	PG31 Holding forces for contact pins	$ F_{(0)} = 7 N^{(2)}$	VW 75174-2
6.27	Slow Motion Bending Test	Crimp measurementContact resistance variation	VW 75174-2
6.28	Breaking Voltage Test	- Visual inspection - Voltage : 500VAC	EIA-364-20

Time: 1min

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6.29	Tin Whisker Formation	 Visual inspection There shall be no evidence of whiskers higher than 50µm 	AFCI GS-19-028C
6.30	Solderability	Visual inspectionSection 4.5 (SMT version)	AFCI GS-19-037
6.31	Resistance to solder heat	Visual inspectionReflow 260°C	AFCI GS-22-011
6.32	Retention on PCB (soldered)	 Visual inspection Retention force (parallel to the plane of the board) > 100N Retention force (normal to the plane of the board) > 50N 	IEC 60950 Chapter 4.23 & 4.24
6.33	MSL test	 Test Condition – Level 1 under 260°C Max There shall be no evidence of tin reflowing and discoloration on power pins 	JEDEC J-STD- 020E

^{(1):} VW 75174-2018-06 standard.

7.0 QUALITY ASSURANCE PROVISIONS

7.1 Equipment Calibration

All test equipment and inspection facilities used in the performance of any test shall be maintained in a calibration system in accordance with ANSI Z-540 and ISO 9000.

7.2 Inspection Conditions

Unless otherwise specified herein, all inspections shall be performed under the following ambient conditions:

a. Temperature: 25 +/- 5 deg Cb. Relative Humidity: 30% to 60%

c. Barometric Pressure: Local ambient

7.3 Sample Quantity And Description

Refer to called standards.

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^{(2):} Dedicated value. MicroSpace™ connector

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7.4 Acceptance

- 7.4.1 Electrical and mechanical requirements placed on test samples as indicated in paragraphs 6.0 shall be established from test data using appropriate statistical techniques or shall otherwise be customer specified, and all samples tested in accordance with this product specification shall meet the stated requirements.
- 7.4.2 Failures attributed to equipment, test setup, or operator error shall not disqualify the product. If product failure occurs, corrective action shall be taken and samples resubmitted for qualification.

7.5 Qualification Testing

Qualification testing shall be performed on sample units produced with equipment and procedures normally used in production. The test sequences shall be as shown in the qualification test table. Data shall be provided with the samples noting production history: production lot codes for components and assemblies, components and assemblies produced to print revision ___, verification of plating composition and thickness, etc.

7.6 Re-Qualification Testing

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If any of the following conditions occur, the responsible product engineer shall initiate requalification testing consisting of all applicable parts of the qualification test matrix.

- a. A significant design change is made to the existing product which impacts the product form, fit or function. Examples of significant changes shall include, but not be limited to, changes in the plating material composition or thickness, contact force, contact surface geometry, insulator design, contact base material, or contact lubrication requirements.
- b. A significant change is made to the manufacturing process which impacts the product form, fit or function.
- c. A significant event occurs during production or end use requiring corrective action to be taken relative to the product design or manufacturing process.

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REVISION RECORD

Rev	Page	<u>Description</u>	EC#	<u>Date</u>
Α	ALL	Release		07/07/2017
В	3, 4,	Modification of requirements :		19/01/2018
	5, 6	Contact resistance, 2 nd locking retention force, Retention force on PCB		
С	1, 4,	Modification of requirements :		28/06/2018
	5, 6	Resistivity, pull out force, 2 nd locking retention force		
D	4, 6	Modification of pull out force for AWG24, AWG26 and AWG28	F-36938	07/05/2020
		PG22A, PG24, PG28 and PG31 added		
Е	1, 3,	Section 3.2 : Operating current rating details	F-48314	25/03/2024
	4, 5	Section 5.3 : Gold update		
		PG7 positive locking retention modification		
		PG17 Gold update		
F	1,2,5	Add HDT CTW SPEC & TG, update voltage rating	F-53077	03/10/2024

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